

SURFACE MOUNT FAST SWITCHING DIODE

Features

- Fast Switching Speed
- Small Surface-Mount Package
- For General-Purpose Switching Applications
- High Conductance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: SOT323
- Package Material: Molded Plastic, "Green" Molding Compound;
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 (3)
- Polarity: See Diagram
- Weight: 0.006 grams (Approximate)





Top View



Top View Internal Schematic

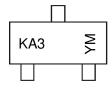
Ordering Information (Notes 4 & 5)

Part Number	Package	Packing	
Fait Number	rackaye	Qty.	Carrier
MMBD4448W-7-F	SOT323	3,000	Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.
- 5. Product manufactured with Green Molding Compound and does not contain Halogens or Sb₂O₃ Fire Retardants.

Marking Information



KA3 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: K = 2023)

M = Month (ex: 1 = January)

Date Code Key

Year	2002		2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	N		K	L	М	N	P	R	S	Т	Ū	V
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	V _{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	75	V
RMS Reverse Voltage	V _R (RMS)	53	V
Forward Continuous Current (Note 6)	I _{FM}	500	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0µ @ t = 1.0s	IECM	4.0 1.0	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P _D	200	mW
Thermal Resistance Junction to Ambient Air (Note 6)	RеJA	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

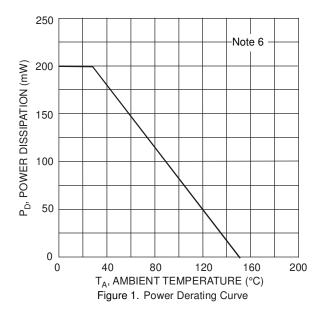
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	75	_	V	$I_R = 10\mu A$
		0.62	0.72		IF = 5.0mA
Forward Voltage	VF	_	0.855	V	$I_F = 10mA$
olward voltage	V F	_	1.0	V	IF = 100mA
			1.25		IF = 150mA
			1.0	μΑ	$V_R = 75V$
Reverse Current (Note 7)	l _R		50	μA	$V_R = 75V, T_J = +150$ °C
neverse current (Note 7)	'R	_	30	μΑ	$V_R = 25V, T_J = +150$ °C
			25	nA	V _R = 20V
Total Capacitance	Ст	1	2.0	pF	$V_R = 0, f = 1.0MHz$
Reverse-Recovery Time	+		4.0	ns	$I_F = I_R = 10mA$,
Tieverse-riecovery rime	t _{rr}		4.0	115	$I_{rr} = 0.1 \times I_R$, $R_L = 100\Omega$

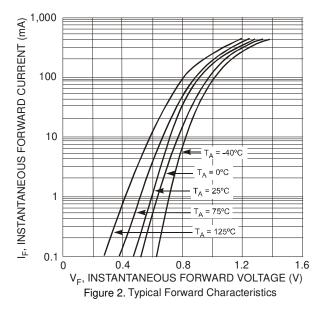
Notes:

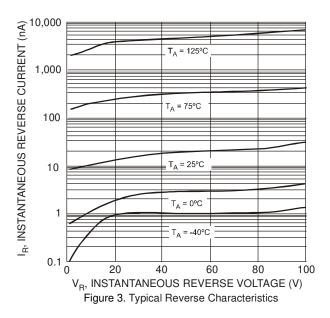
^{6.} Device mounted on FR-4 PCB, 1inch × 0.85inch × 0.062inch; pad layout as shown on Diodes Incorporated's suggested pad layout document, which can be found on our website at http://www.diodes.com/package-outlines.html.

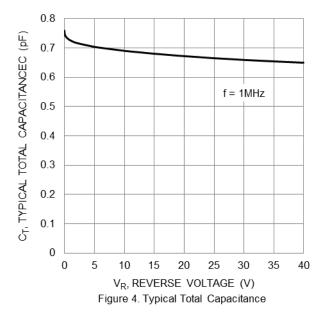
^{7.} Short duration pulse test used to minimize self-heating effect.











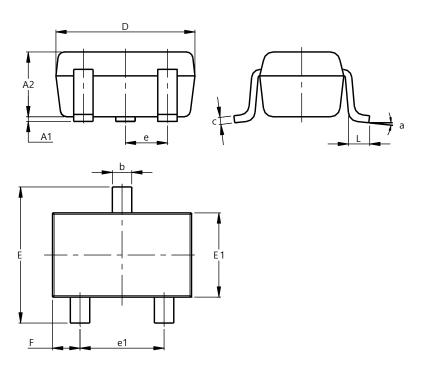
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Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT323

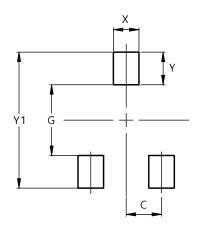


SOT323						
Dim	Min	Max	Тур			
A1	0.00	0.10	0.05			
A2	0.90	1.00	0.95			
b	0.25	0.40	0.30			
С	0.10	0.18	0.11			
D	1.80	2.20	2.15			
Е	2.00	2.20	2.10			
E1	1.15	1.35	1.30			
е	0.650 BSC					
e1	1.20	1.40	1.30			
F	0.375	0.475	0.425			
L	0.25	0.40	0.30			
а	0°	8°				
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT323



Dimensions	Value (in mm)
С	0.650
G	1.300
Х	0.470
Y	0.600
Y1	2.500



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